LDS0705

Shielded metalized drum core power inductors



Applications

- **Buck or Boost Inductor**
- Noise filtering and output filter chokes
- Battery Power, DC-DC converters
- Notebook and laptop power
- Hand held devices
- Media players

Environmental data

- Storage temperature range (component): 40 °C to +125 °C
 - Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant









Product specifications

Part Number	Rated Inductance (µH)	OCL (1) μΗ	Irms(2) (A)	Isat (3) (A)	DCR (Ω) @+20 °C (Typical)	K-factor (4)
LDS0705-R82M-R	0.82	0.861±20%	7.68	8.57	0.0040	24.8
LDS0705-1R5M-R	1.5	1.42±20%	6.17	6.67	0.0061	19.3
LDS0705-2R2M-R	2.2	2.13±20%	5.06	5.45	0.009	15.8
LDS0705-3R3M-R	3.3	2.97±20%	4.19	4.62	0.013	13.4
LDS0705-4R7M-R	4.7	5.08±20%	3.32	3.53	0.021	10.2
LDS0705-6R8M-R	6.8	6.34±20%	3.11	3.16	0.024	9.2
LDS0705-8R2M-R	8.2	7.75±20%	2.67	2.86	0.033	8.3
LDS0705-100M-R	10.0	9.30±20%	2.54	2.61	0.036	7.6
LDS0705-150M-R	15.0	14.78±20%	2.04	2.07	0.056	6.0
LDS0705-220M-R	22.0	21.53±20%	1.66	1.71	0.084	5.0
LDS0705-330M-R	33.0	32.50±20%	1.48	1.40	0.107	4.0
LDS0705-470M-R	47.0	45.71±20%	1.21	1.18	0.158	3.4
LDS0705-680M-R	68.0	69.76±20%	0.985	0.952	0.240	2.8
LDS0705-820M-R	82.0	83.67±20%	0.850	0.870	0.323	2.5
LDS0705-101M-R	100.0	98.9±20%	0.808	0.800	0.357	2.3
LDS0705-151M-R	150.0	152.0±20%	0.649	0.645	0.554	1.9
LDS0705-221M-R	220.0	216.5±20%	0.584	0.541	0.68	1.6
LDS0705-331M-R	330.0	329.9±20%	0.470	0.438	1.06	1.3
LDS0705-471M-R	470.0	467.0±20%	0.387	0.368	1.56	1.1

- (1) Open Circuit Inductance Test Parameters: 100 kHz, 0.1 V, 0.0 Adc.
- (2) Irms: DC current for an approximate ΔT of 30 °C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed +125 °C under worst case operating conditions verified in the end application.
- (3) Isat Amperes peak for approximately 15% rolloff (@+25 °C)

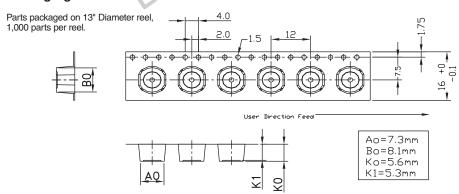
- (4 K-factor: Used to determine B p-p for core loss (see graph). B p-p = K*L*Δ, B p-p(mT), K: (K factor from table), L: (Inductance in μH),
 - Δ (Peak to peak ripple current in Amps).
- (5) Part Number Definition: LDS0705-xxx-R

Dimensions- mm

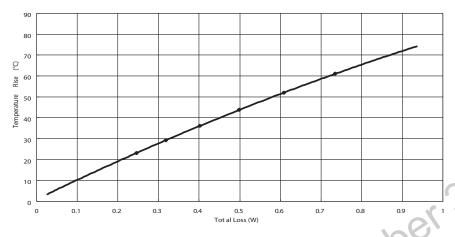


Marking: xxx = Inductance in UH. P = decimal point. If no P is present last characterequals number of zeros. wwlly y = Date code. R = Revision level. Do not route traces or vias underneath the inductor

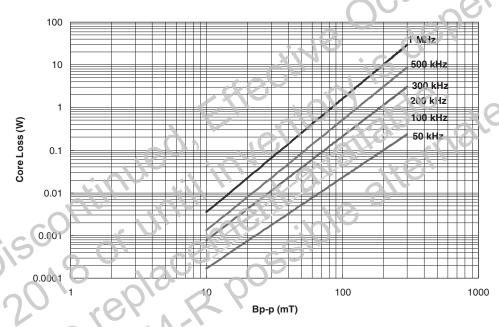
Packaging information- mm



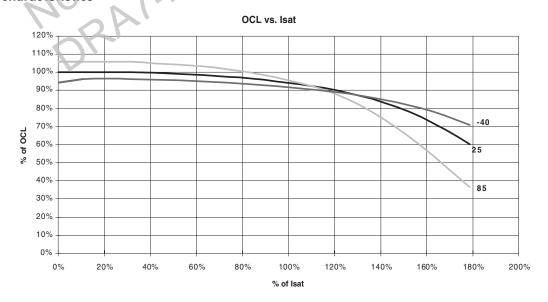
Temperature rise vs. total loss



Core loss vs Bp-p



Inductance characteristics



Solder Reflow Profile

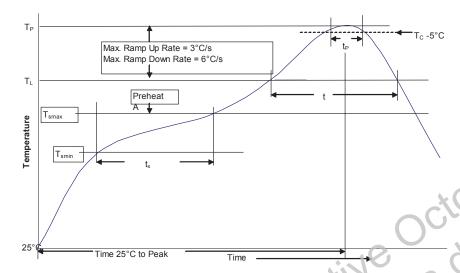


Table 1 - Standard SnPb Solder (T_c)

		Volume	Volume	
Package		mm³	mm³	
	Thickness	<350	≥350	
	<2.5mm	235°C	220°C	
	≥2.5mm	220°C	220°C	

Table 2 - Lead (Pb) Free Solder (Tc)

Package	Volume mm³	Volume mm³	Volume mm³
Thickness	<350	350 - 2000	>2000
<1.6mm	260°C	260°C	260°C
1.6 - 2.5mm	1 260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020

Profile Feature	140	Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	Temperature min. (T _{smin})	100°C	150°C
	 Temperature max. (T_{smax}) 	150°C	200°C
	• Time (T _{smin} to T _{smax}) (t _s)	60-120 Seconds	60-120 Seconds
Average ramp up rat	e T _{smax} to T _p	3°C/ Second Max.	3°C/ Second Max.
Liquidous temperatu	re (l'L)	183°C	217°C
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds
Peak package body	emperature (Tp)*	Table 1	Table 2
	°C of the specified classification temperature (i _c)	20 Seconds**	30 Seconds**
Average ramp-down	rate (T _p to T _{smax})	6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak 7	emperature	6 Minutes Max.	8 Minutes Max.

^{*} Tolerance or peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

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^{**} Tolerance for time at peak profile temperature (tp) is defined as a supplier minimum and a user maximum.

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